onsemi

MOSFET – Power, for 1-Cell Lithium-ion Battery Protection, Dual N-Channel

12 V, 13 A, 9.0 m Ω

EFC6604R

This Power MOSFET features a low on-state resistance. This device is suitable for applications such as power switches of portable machines. Best suited for 1-cell lithium-ion battery applications.

Features

- 2.5 V Drive
- 2 kV ESD HBM
- Common-Drain Type
- ESD Diode-Protected Gate
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

• 1-Cell Lithium-ion Battery Charging and Discharging Switch

Specifications

ABSOLUTE MAXIMUM RATINGS (T_A = 25° C)

Parameter	Symbol	Value	Unit
Source-to-Source Voltage	V _{SSS}	12	V
Gate-to-Source Voltage	V _{GSS}	±12	V
Source Current (DC)	I _S	13	А
Source Current (Pulse) PW \leq 10 μ s, duty cycle \leq 1%	I _{SP}	60	A
Total Dissipation (Note 1)	P _T	1.6	W
Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	– 55 to +150	°C

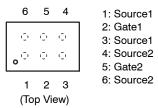
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction to Ambient (Note 1)	$R_{\theta JA}$	78.1	°C/W
	-		

1. Surface mounted on ceramic substrate (5000 mm² x 0.8 mm)

PIN ASSIGNMENT



V _{SSS}	R _{SS(on)} Max	I _S Max
12 V	9.0 mΩ @ 4.5 V	13 A
	9.7 mΩ @ 4.0 V	
	10.0 mΩ @ 3.8 V	
	12.7 mΩ @ 3.1 V	
	17.7 mΩ @ 2.5 V	



WLCSP6 1.91x1.46 / EFCP1915-6CE-020 CASE 614AC

MARKING DIAGRAM

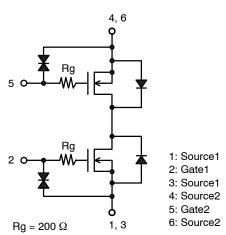


MD = Specific Device Code

- Y = Year of Production
- M = Assembly Operation Month
- ZZ = Assembly Lot Number

ELECTRICAL CONNECTION

N-Channel



ORDERING INFORMATION

Device	Package	Shipping
EFC6604R-TR	WLCSP6 (Pb-Free and Halogen Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Parameter	Symbol	Conditio	ns	Min	Тур	Max	Unit
Source-to-Source Breakdown Voltage	V _{(BR)SSS}	I _S = 1 mA, V _{GS} = 0 V	Test Circuit 1	12	-	-	V
Zero-Gate Voltage Source Current	I _{SSS}	V_{SS} = 10 V, V_{GS} = 0 V	Test Circuit 1	-	-	1	μA
Gate-to-Source Leakage Current	I _{GSS}	V_{GS} = ±8 V, V_{SS} = 0 V	Test Circuit 2	-	-	±1.0	μA
Gate Threshold Voltage	V _{GS} (th)	V_{SS} = 6 V, I_S = 1 mA	Test Circuit 3	0.5	-	1.3	V
Forward Transconductance	9 _{FS}	$V_{SS} = 6 V, I_{S} = 3 A$	Test Circuit 4	-	13.7	-	S
Static Source-to-Source On-State Resistance	R _{SS} (on)1	$I_{\rm S}$ = 3 A, $V_{\rm GS}$ = 4.5 V	Test Circuit 5	6.0	7.5	9.0	mΩ
	R _{SS} (on)2	$I_{\rm S}$ = 3 A, $V_{\rm GS}$ = 4.0 V	Test Circuit 5	6.4	8.1	9.7	mΩ
	R _{SS} (on)3	$I_{\rm S}$ = 3 A, $V_{\rm GS}$ = 3.8 V	Test Circuit 5	6.7	8.4	10.0	mΩ
	R _{SS} (on)4	$I_{\rm S}$ = 3 A, $V_{\rm GS}$ = 3.1 V	Test Circuit 5	7.8	9.8	12.7	mΩ
	R _{SS} (on)5	$I_{\rm S}$ = 3 A, $V_{\rm GS}$ = 2.5 V	Test Circuit 5	10.0	12.6	17.7	mΩ
Turn-ON Delay Time	t _d (on)	$V_{SS} = 6 V, V_{GS} = 4.5 V,$	Test Circuit 6	-	300	-	ns
Rise Time	t _r	I _S = 3 A		-	1200	-	ns
Turn-OFF Delay Time	t _d (off)			-	5200	-	ns
Fall Time	t _f			-	3900	-	ns
Total Gate Charge	Qg	$V_{SS} = 6 V$, $V_{GS} = 4.5 V$, $I_{S} = 13 A$	Test Circuit 7	-	29	-	nC
Forward Source-to-Source Voltage	V _{F(S-S)}	I _S = 3 A, V _{GS} = 0 V	Test Circuit 8	-	0.75	1.2	V

ELECTRICAL CHARACTERISTICS (T_A = 25° C)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Test circuits are example of measuring FET1 side.

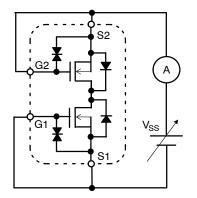


Figure 1. Test Circuit 1 – V_{SSS} / I_{SSS}

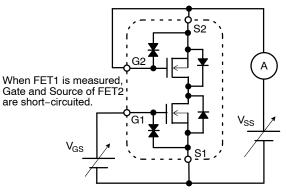
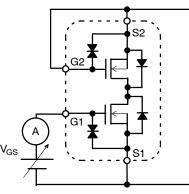


Figure 3. Test Circuit 3 – V_{GS}(th)



When FET1 is measured, Gate and Source of FET2 are short-circuited.

Figure 2. Test Circuit 2 – I_{GSS}

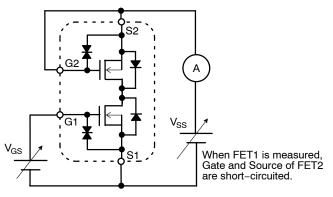


Figure 4. Test Circuit 4 – g_{FS}

TEST CIRCUITS (continued)

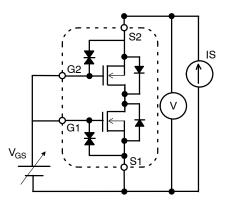


Figure 5. Test Circuit 5 – R_{SS}(on)

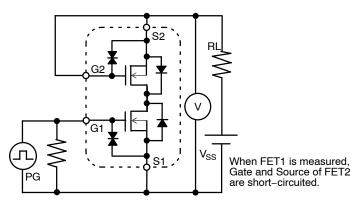


Figure 6. Test Circuit 6 – $t_d(on)$, t_r , $t_d(off)$, t_f

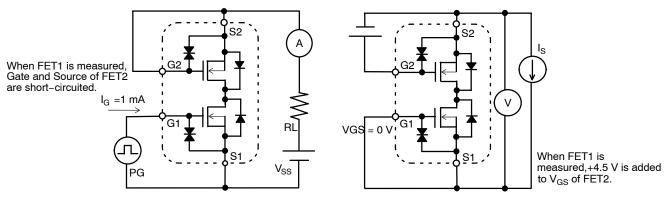
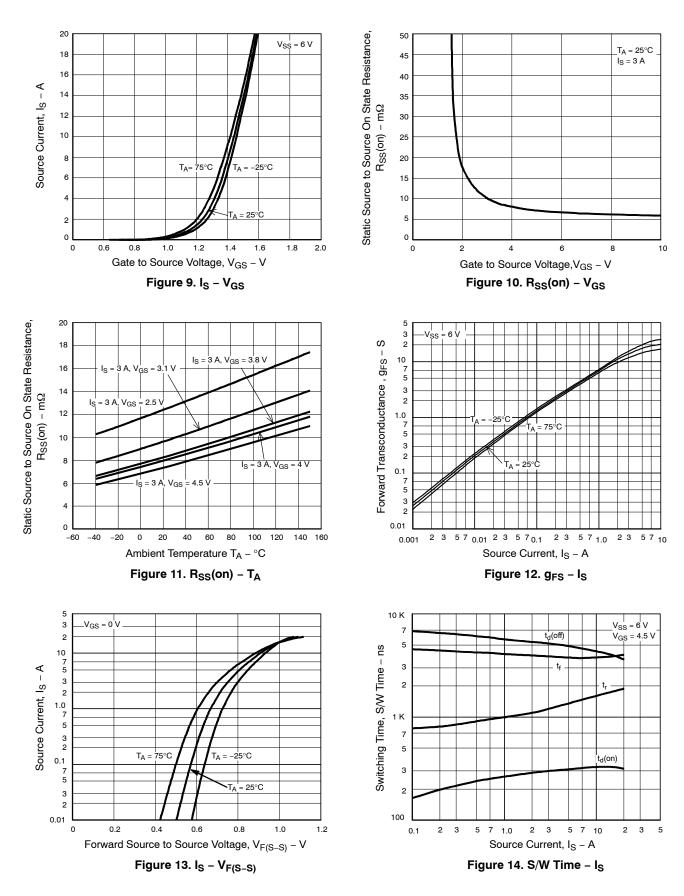


Figure 7. Test Circuit 7 – Qg

Figure 8. Test Circuit 8 – V_{F(S-S)}

When FET2 is measured, the position of FET1 and FET2 is switched.



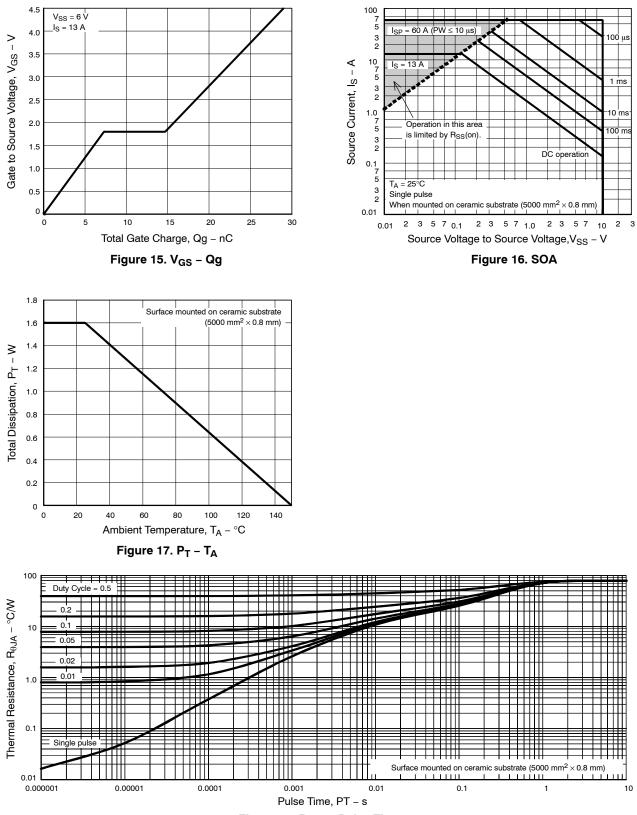
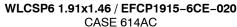


Figure 18. $R_{\theta JA}$ – Pulse Time

Note on usage: Since the EFC6604R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects. Please contact sales for use except the designated application.

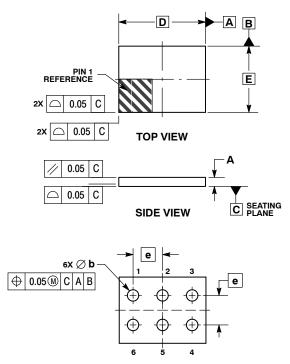
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ISSUE B

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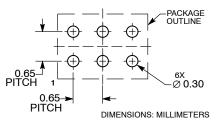


BOTTOM VIEW

NOTES: DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.18	0.22	
b	0.27	0.33	
D	1.91 BSC		
E	1.46 BSC		
е	0.65 BSC		

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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